



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re U.S. Patent Application of)
SHIMAMOTO *et al.*)
Application Number: 10/020,314) Art Unit 2823
Filed: December 18, 2001) Examiner Nguyen, Khiem D.
For: FABRICATING METHOD OF)
SEMICONDUCTOR INTEGRATED CIRCUITS)
Attorney Docket No. HITA.0143)

Honorable Assistant Commissioner for Patents
Washington, D.C. 20231

COVER LETTER

Sir:

[] The fee for submission of claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL CURRENTLY ON FILE	CLAIMS PAID	RATE	CALCULATION
Total Claims	29	20	(Over 20)	x \$50	450.00
Independent Claims	2	2	(Over 3)	x \$200	0
MULTIPLE DEPENDENT CLAIM(S)				+ \$360	0
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED					
			TOTAL		450.00

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

[<input checked="" type="checkbox"/>] Response to Office Action (w/ claim amendments)	[<input type="checkbox"/>] Petition for ____-month Extension-of-Time
[<input type="checkbox"/>] Substitute Abstract	[<input type="checkbox"/>] Terminal Disclaimer
[<input type="checkbox"/>] Preliminary Amendment	[<input type="checkbox"/>] Letter to Draftsman w/ _____ sheets of drawings
[<input type="checkbox"/>] Other _____	[<input type="checkbox"/>] Sequence Listing
	[<input type="checkbox"/>] Sequence Listing Diskette _____

Please charge my **Deposit Account Number** _____ in the amount of _____ to cover the fees for _____. A duplicate copy of this paper is enclosed.

A check in the amount of **\$450.00** to cover the excess claims fee is enclosed.

The Commissioner is hereby authorized to charge any additional fees associated with this communication, or credit any overpayment to **Deposit Account Number 08-1480**.

Respectfully submitted,

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January 6, 2005



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Washington, D.C. 20231**

RESPONSE AND AMENDMENT UNDER 37 C.F.R. §1.111

Sir:

This is in response to the office action dated October 14, 2004, in the above identified application, the period for response is set to expire on January 14, 2005. Please amend the above identified application as follows:

01/07/2005 AADDF01 00000069 10020314

01 FC:1252

450.00 OP